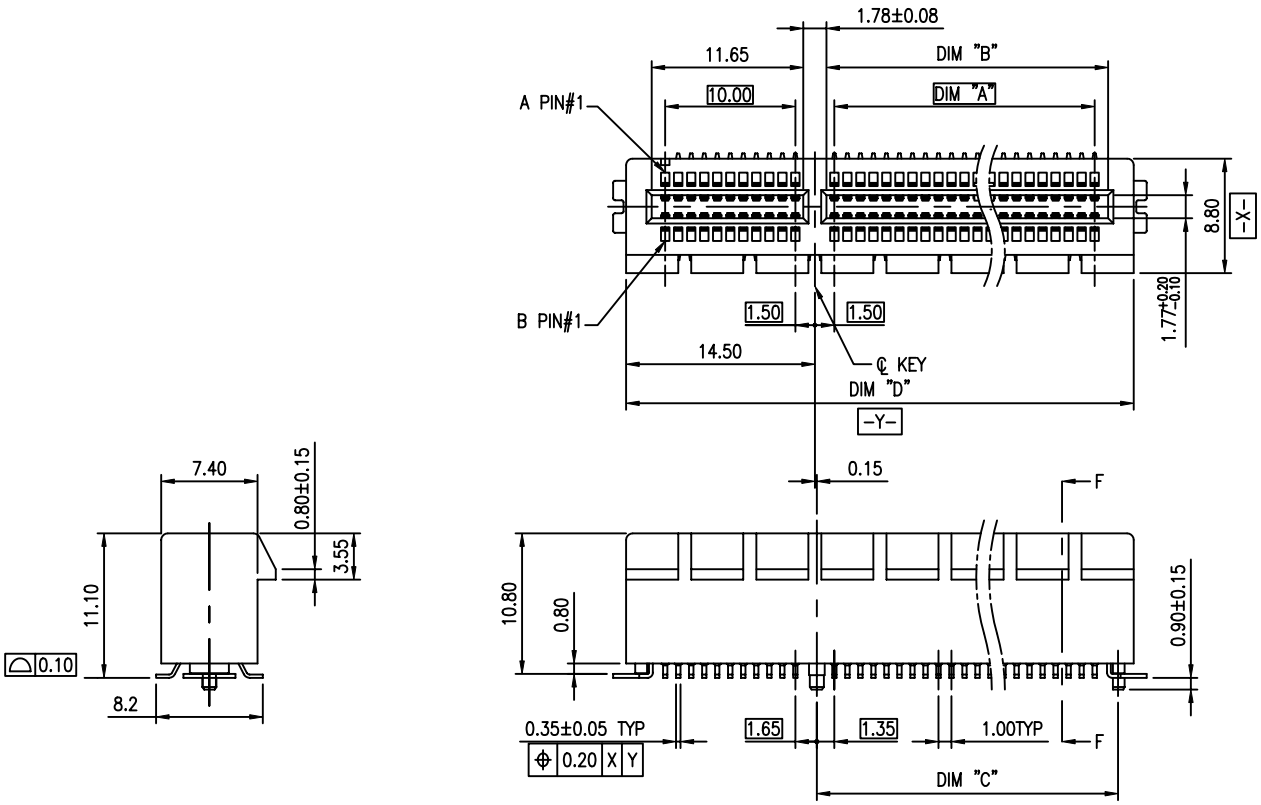
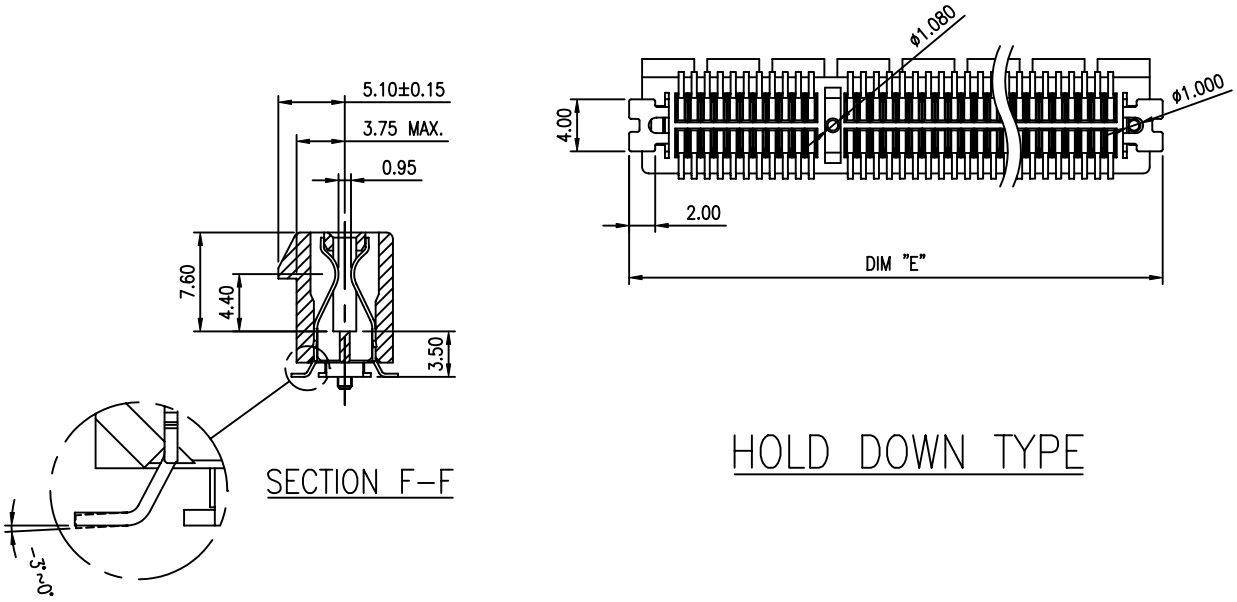
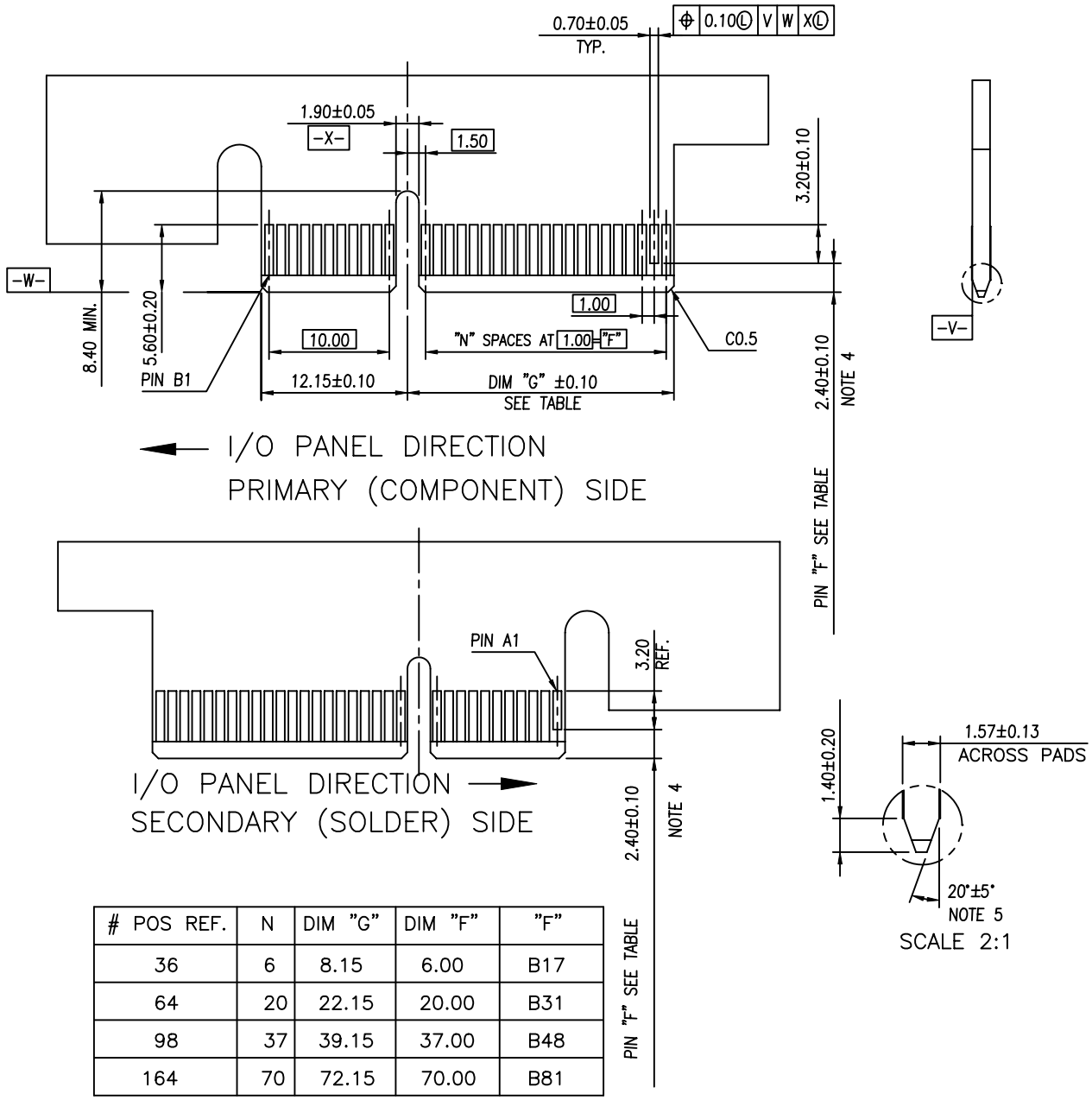




HOLD DOWN TYPE

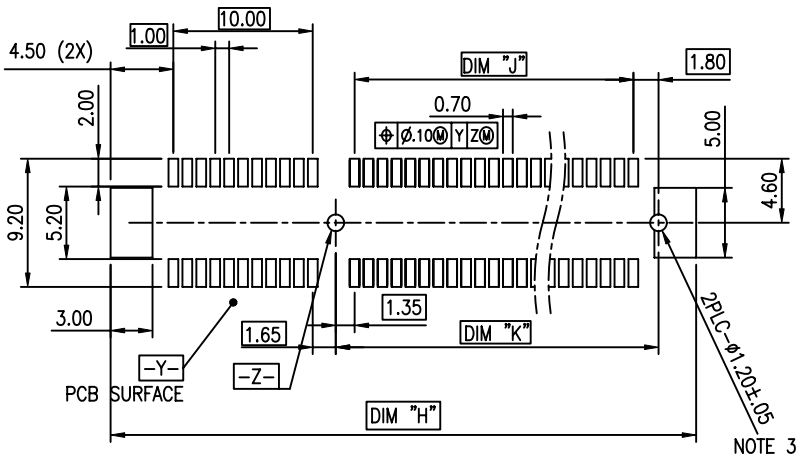
| | | |



# POS REF.	N	DIM "G"	DIM "F"	"F"
36	6	8.15	6.00	B17
64	20	22.15	20.00	B31
98	37	39.15	37.00	B48
164	70	72.15	70.00	B81

ADD-IN CARD EDGE-FINGER DIMENSIONS

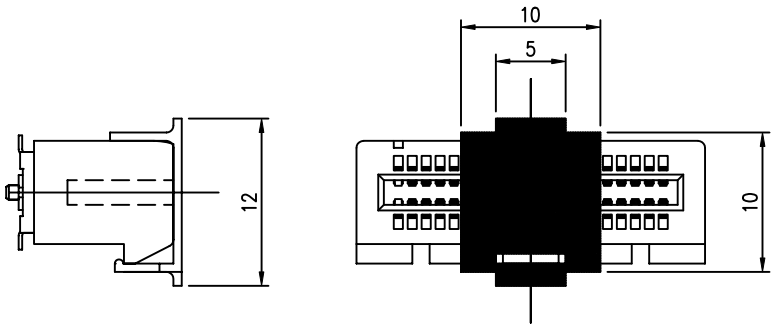
| | | |



RECOMMENDED PCB LAYOUT, PAD TYPE

DIMENSIONS								
POSITION	A	B $^{\pm0.15}_{-0.05}$	C ±0.20	D ±0.23	E ±0.20	H ±0.10	J	K ±0.10
36	6.00	7.65	9.15	25.00	27.00	28.00	6.00	9.15
64	20.00	21.65	23.15	39.00	41.00	42.00	20.00	23.15
98	37.00	38.65	40.15	56.00	58.00	59.00	37.00	40.15
164	70.00	71.65	73.15	89.00	91.00	92.00	70.00	73.15

POSTION OF CAP



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NOTES:

1.MATERIAL:

HOUSING: NYLON, GLASS FILLED UL94V-0 RATE, SUITABLE FOR I.R SOLDERING.

TERMINAL: COPPER ALLOY

PLATING: 50u" NICKEL UNDERPLATE ALL OVER
CONTACT AREA PLATING – SEE PRODUCT NUMBER CODE
SOLDER TAIL: TIN 100u" OVER 50u" NICKEL

METAL PADS: COPPER ALLOY
FINISH: 100u" TIN OVER 50u" NICKEL

2.PRODUCT SPECIFICATION: GS-12-390

③THE HORIZONTAL AXIS FOR THE PAD PATTERN IS ESTABLISHED BY A LINE THROUGH THE CENTER OF THE TWO ø1.0 HOLES. THE VERTICAL AXIS IS 90° TO THE HORIZONTAL AXIS, THROUGH THE CENTER OF DATUM [-Z-]

④NO TIE BAR PERMITTED FROM CARD EDGE TO LEADING EDGE OF PAD FOR PINS A1.

⑤CHAMFER EDGES MUST BE FREE OF CUTTING BURRS.

7.RoHS COMPATIBLE PRODUCT SPECIFICATIONS

a – PLATING:
– "LF" MEANS THE PRODUCT IS LEAD-FREE, 2um MINIMUM MATTE TIN OVER 1.27um MINIMUM NICKEL UNDERPLATE.

b – MANUFACTURING PROCESS COMPATIBILITY
– THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C±5°C PEAK TEMPERATURE FOR 5 SECONDS IN A CONVECTION, INFRA-RED OR VAPOR PHASE REFLOW OVEN.

PRODUCT NUMBER CODE

10061913-X X X X L F

HOUSING COLOR OPTIONS
0-WHITE
1-BLACK

LEAD FREE

PACKAGING OPTIONS
T-TRAY PACKAGING WITHOUT CAP
R-TAPE & REEL PACKING WITHOUT CAP (FOR 36P&64P OPTIONS ONLY)
P-TAPE & REEL PACKING WITH CAP (FOR 36P&64P OPTIONS ONLY)
C-TRAY PACKAGING WITH CAP (FOR 36,64,98P OPTIONS ONLY)

TERMINAL PLATING OPTIONS
0-50u" Ni UNDERPLATE
30u" Au CONTACT AREA
100u" TIN TAIL AREA ----- COMPATIBLE RoHS
1-50u" Ni UNDERPLATE
15u" Au CONTACT AREA
100u" TIN TAIL AREA ----- COMPATIBLE RoHS
2-50u" Ni UNDERPLATE
GOLD FLASH CONTACT AREA
100u" TIN TAIL AREA ----- COMPATIBLE RoHS

POS OPTIONS
0-36
1-64
2-98
3-164

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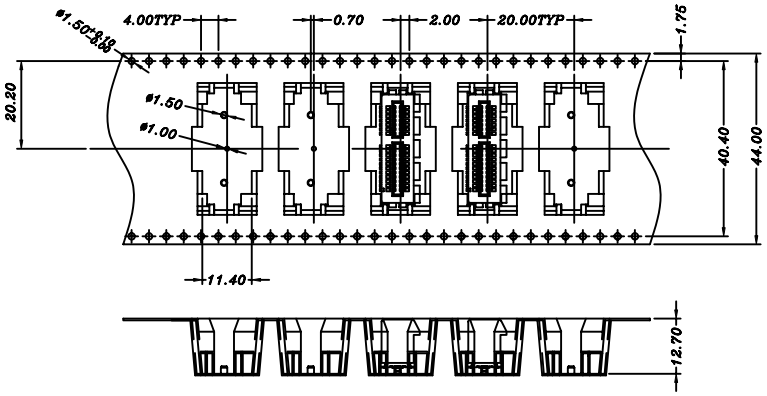
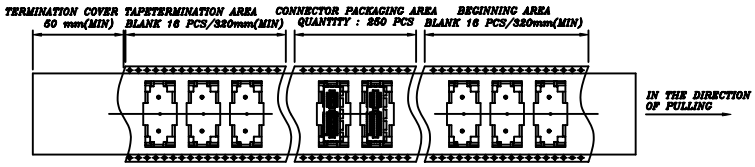
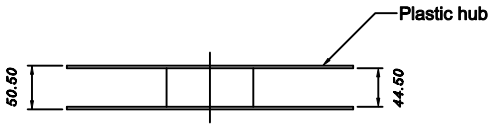
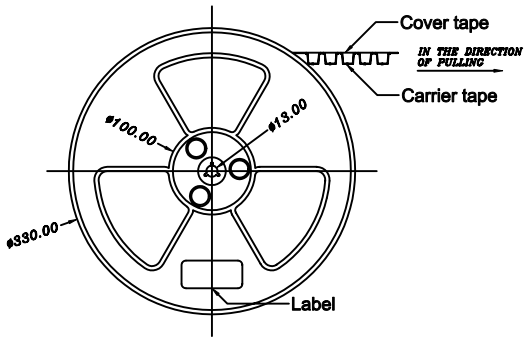




COMPOSITION OF PACKAGING





TAPE AND REEL
PACKING
RECOMMENDED FOR
36PINS ONLY

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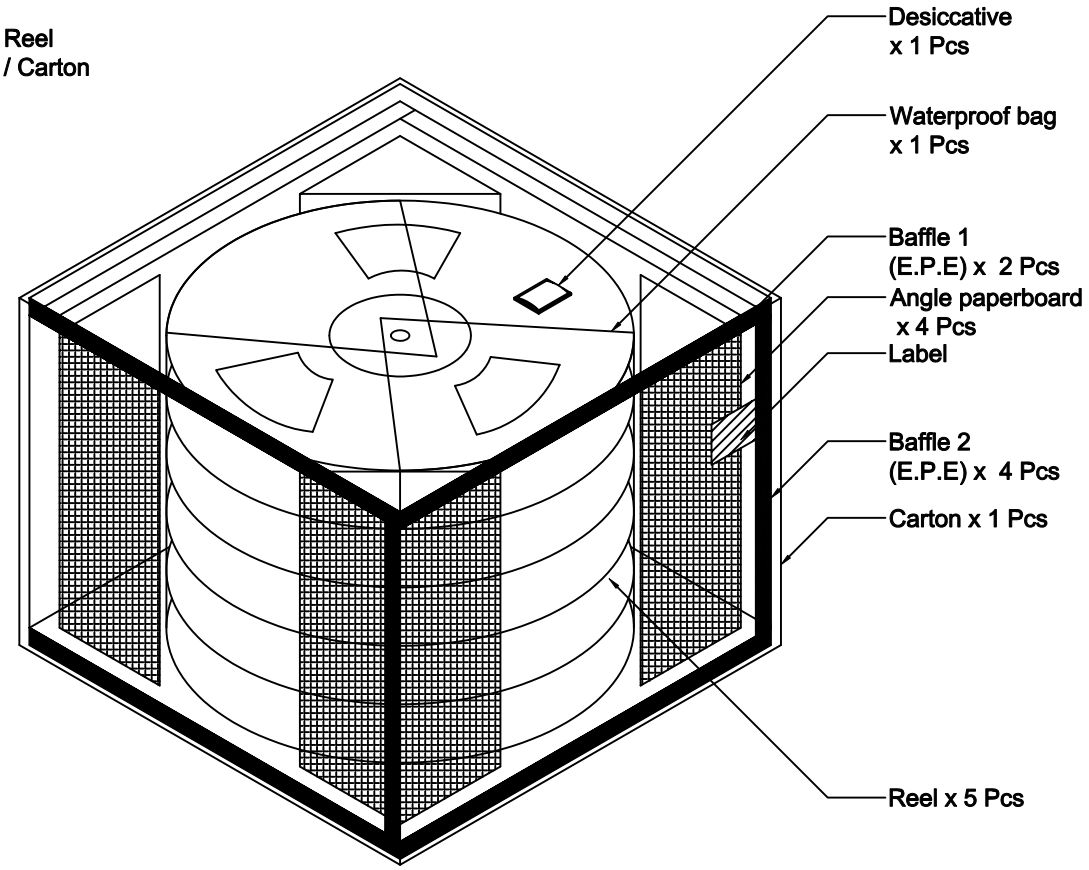
1 For PCI EXPRESS SMT TYPE 36P ONLY.

2. Material :
- 2.1 Reel :
  - 2.1.1 Plastic hub : High Impact Polystyrene
  - 2.1.2 Cover tape : PE
  - 2.1.3 Carrier tape : ABS
- 2.2 Waterproof bag : PE
- 2.3 Desiccative : Silica Gel
- 2.4 Carton : Corrugated paper
- 2.5 Baffle : E.P.E
- 2.6 Angle paperboard : Corrugated paper

3. Dimension :
- 3.1 Reel :
  - 3.1.1 Plastic hub : ø330 x T50.5 mm
  - 3.1.2 Cover tape : 5690(L) x 37.4(W) mm
  - 3.1.3 Carrier tape : 5640(L) x 44(W)mm
- 3.2 Waterproof bag : 600(H) x 465(W) x 0.06(T) mm
- 3.3 Desiccative : 25 gram / Package
- 3.4 Carton : 380(L) x 380(W) x 300(H) mm
- 3.5 Baffle (1): 370(L) x 370(W) x 15(H) mm
- 3.6 Baffle (2): 355(L) x 252(W) x 15(H) mm
- 3.7 Angle paperboard : 252(H)

4. Quantity :
- 4.1 250 Pcs / Reel
- 4.2 1250 Pcs / Carton

5. Weight :
- 5.1 N/W :
- 5.2 G/W :



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